

Influence of RF sputtering power during RFMS on the electrochemical behavior of zirconia thin films in a Hanks solution

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INTRODUCTION & AIM

Zirconia (ZrO_2) thin films have become very attractive to the coating industry thanks to its remarkable properties. ZrO_2 can exist in the monoclinic, tetragonal or cubic phases depending on the temperature. These interesting properties have led to numerous efforts to deposit ZrO_2 films by various techniques, including chemical vapor deposition (CVD) [1], sol-gel techniques [2]... and sputtering [3]. Magnetron sputtering offers good control over the deposition rate, and film composition [3, 4]. The aim of this study was to prepare ZrO_2 thin films using RF magnetron sputtering method at different sputtering power and to systematically investigate how the sputtering power affects their microstructure, surface morphology, hydrophobicity and electrochemical behavior in a physiological environment.

METHOD

A pure zirconium target was sputtered in Ar-O_2 gas mixture. The sputtering power was varied in order to investigate its influence on the film's properties.

Target	Pure Zirconium (99.99%)
Target-Substrate distance	30 mm
Base Pressure	1.0×10^{-6} Torr
Sputtering gas	20 sccm of Ar
Reactive gas fraction	30% of O_2
Sputtering Power	100- 250- 400 W
Deposition time	60 min
Substrate Bias	-100 V

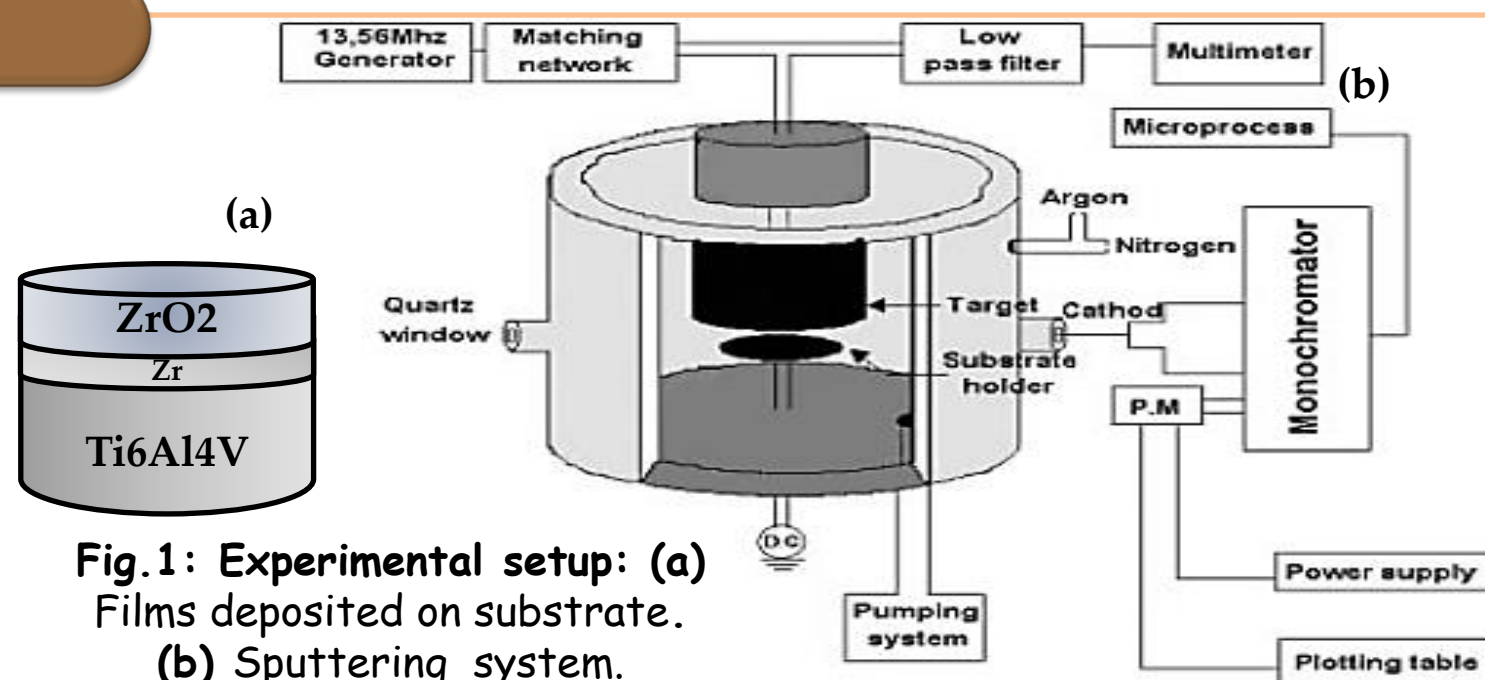


Fig.1: Experimental setup: (a) Films deposited on substrate. (b) Sputtering system.

RESULTS & DISCUSSION

Morphology :

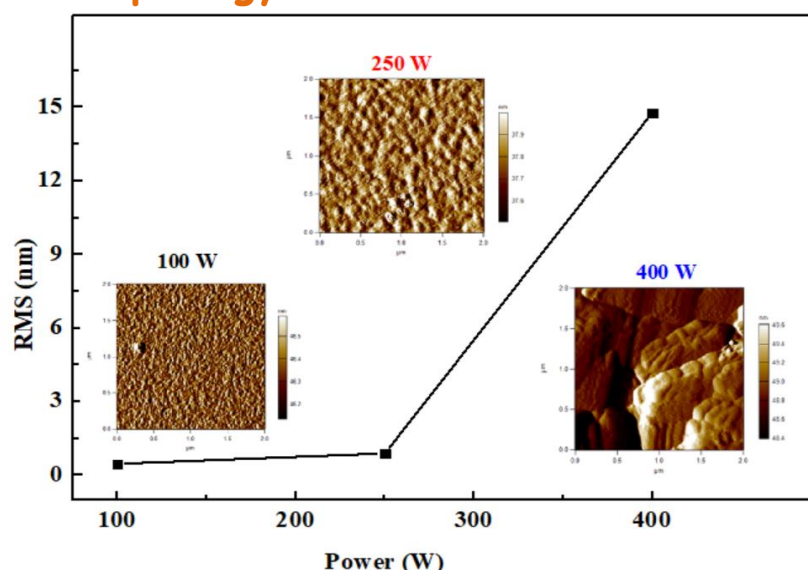


Fig.2: Roughness and AFM images of the surface morphology of deposited ZrO_2

Structure:

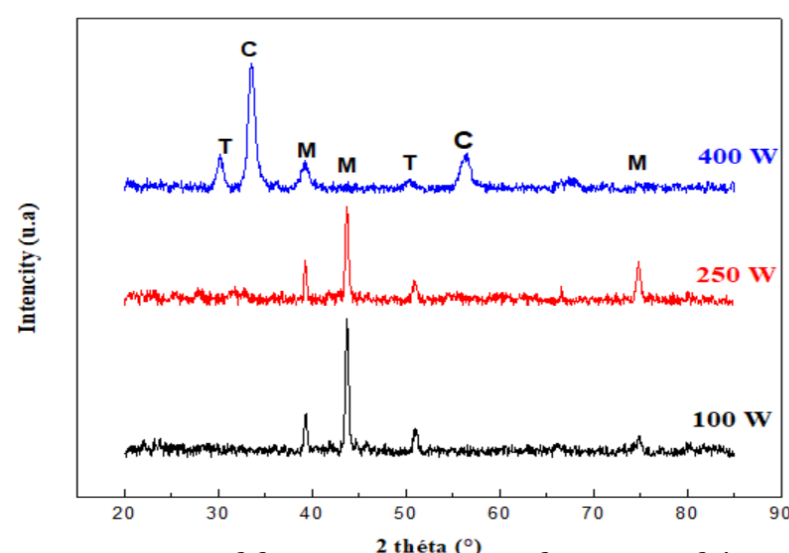


Fig.3: Diffractograms of ZrO_2 films at different sputtering power

Hydrophobicity :



Fig.4 : Contact angle and images of the water droplets on ZrO_2 deposited films

Electrochemical behavior

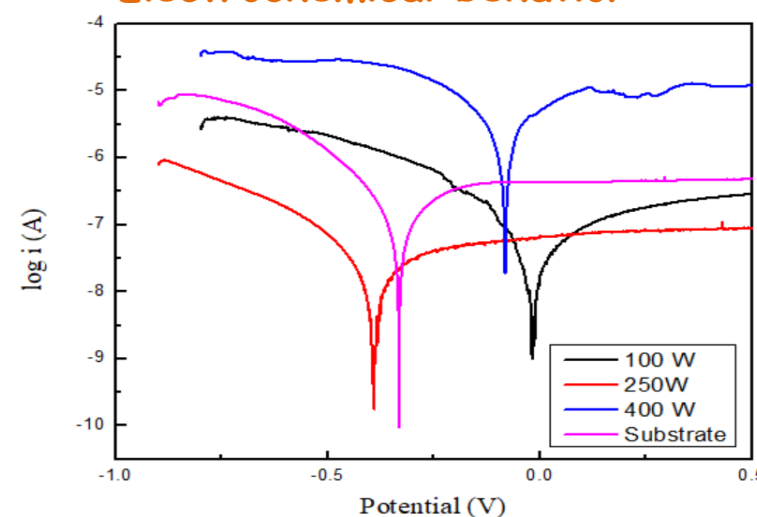


Fig.5: Effect of sputtering power on the polarization curves of coated and uncoated substrate in Hanks' solution

The electrochemical behavior of the films was assessed through potentiodynamic polarization tests in Hank's solution at a temperature close to that of the human body.

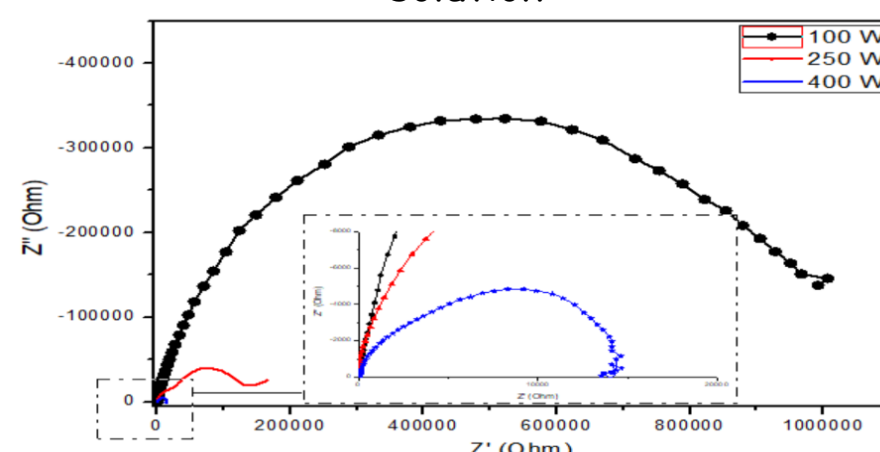


Fig.6: the Nyquist plot for ZrO_2 deposited films.

CONCLUSION

The Zirconia coatings were successfully prepared using RF magnetron sputtering. The AFM results showed that Higher sputtering power led to a significance increase in the surface roughness, and induced a crystalline phase transition from monoclinic to cubic structure. the contact angle measurement showed that a sputtering power of 250 W produced the most hydrophobic films. the electrochemical results showed that the Zirconia films exhibited a protective anti-corrosive performance. In conclusion, the results demonstrate that the sputtering power is a key depositing parameter for tailoring different properties of zirconia thin films, confirming their potential as a protective coating for biomedical metals.

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